

Low Capacitance, Single-Line ESD-Protection Diode

Features

- Ultra compact LLP1006-2L package
- Low package height < 0.4 mm
- 1-line ESD-protection
- Low leakage current < 0.1 μA
- Low load capacitance C_D = 1.3 pF
- ESD-protection to IEC 61000-4-2
 ± 15 kV contact discharge
 ± 15 kV air discharge
- High surge current acc. IEC61000-4-5 I_{PP} > 3 A
- Soldering can be checked by standard vision inspection. No X-ray necessary
- Lead (Pb)-free component
- Pin plating NiPdAu (e4) no whisker growth
- "Green" molding compound
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

Marking (example only)

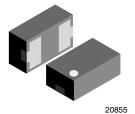




X = Date code

Y = Type code (see table below)







Ordering Information

| Device name | Device name Ordering code | | Minimum order quantity | | |
|---------------|---------------------------|------|------------------------|--|--|
| VBUS051BD-HD1 | VBUS051BD-HD1-GS08 | 8000 | 8000 | | |

Package Data

| Device name | Package name | Type code | Weight | Molding compound flammability rating | Moisture sensitivity level | Soldering conditions |
|---------------|-----------------|--------------|---------|--------------------------------------|--------------------------------------|--------------------------|
| VBUS051BD-HD1 | LLP1006-2L | А | 0.72 mg | UL 94 V-0 | MSL level 1 (according J-STD-020) | 260 °C/10 s at terminals |

Absolute Maximum Ratings

| Parameter | Test conditions | Symbol | Value | Unit |
|-----------------------|--|------------------|---------------|------|
| Peak pulse current | Acc. IEC 61000-4-5; $t_P = 8/20 \mu s$; single shot | I _{PPM} | 3 | Α |
| Peak pulse power | Acc. IEC 61000-4-5; $t_P = 8/20 \mu s$; single shot | P _{PP} | 45 | W |
| ESD immunity | Contact discharge acc. IEC 61000-4-2; 10 pulses | V _{ESD} | ± 15 | kV |
| | Air discharge acc. IEC 61000-4-2; 10 pulses | V_{ESD} | ± 15 | kV |
| Operating temperature | Junction temperature | T_J | - 40 to + 125 | °C |
| Storage temperature | | T _{STG} | - 40 to + 150 | °C |

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Electrical Characteristics

Ratings at 25 °C, ambient temperature unless otherwise specified

VBUS051BD-HD1

| Parameter | Test conditions/remarks | Symbol | Min. | Тур. | Max. | Unit |
|--------------------------------|---|------------------|------|--------|------|-------|
| Protection paths | Number of line which can be protected | N lines | | | 1 | lines |
| Reverse working voltage | at $I_R = 0.1 \mu A$; pin 2 to pin 1 | V _{RWM} | 5 | | | V |
| Max. reverse current | at $V_R = V_{RWM} = 5 V$; pin 2 to pin 1 | I _R | | < 0.01 | 0.1 | μΑ |
| Min. reverse breakdown voltage | at I _R = 1 mA pin 2 to pin 1 | V _{BR} | 6.9 | 7.9 | 8.7 | V |
| Max. clamping voltage | at I _{PP} = 3 A; acc. IEC 61000-4-5; pin 2 to pin 1 | V _C | | | 16 | V |
| Max. forward clamping voltage | at I _F = 3 A; acc. IEC 61000-4-5; pin 1 to pin 2 | V _F | | 1.9 | 2.5 | ٧ |
| Line capacitance | at $V_R = 0$ V; $f = 1$ MHz; pin 2 to pin 1 | C _D | | 1.3 | 1.8 | pF |

Application Note

The **VBUS051BD-HD1** is an ESD-protection device with the characteristic of a Z-Diode with a high ESD-immunity and a very low capacitance which makes it usable for high frequency applications like USB2.0 or HDMI

With the **VBUS051BD-HD1** one high speed data line can be protected against transient voltage signals like ESD (Electro Static Discharge). Connected to the data line (pin 2) and to ground (pin 1) negative transients will be clamped close below the ground level while positive transients will be clamped close above the 5 V working range. The clamping behaviour of the **VBUS051BD-HD1** is bidirectional but asymmetrical (**BiAs**) and so it offers the best protection for applications running up to 5 V.

Typical Characteristics

T_{amb} = 25 °C, unless otherwise specified

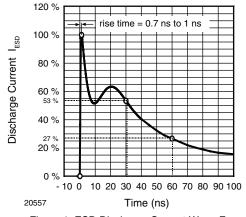


Figure 1. ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 Ω /150 pF)

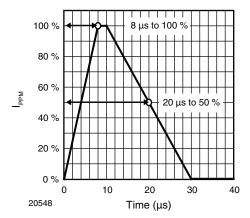


Figure 2. 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5



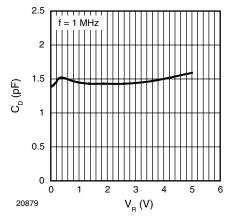


Figure 3. Typical Capacitance C_{D} vs. Reverse Voltage V_{R}

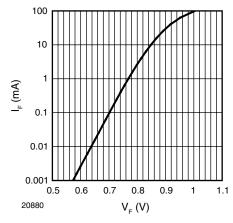


Figure 4. Typical Forward Current I_F vs. Forward Voltage V_F

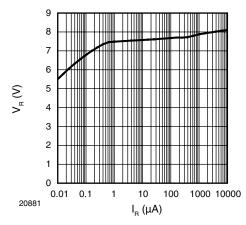


Figure 5. Typical Reverse Voltage V_R vs. Reverse Current I_R

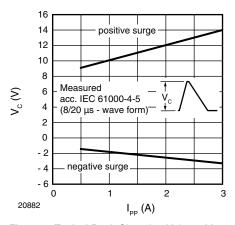


Figure 6. Typical Peak Clamping Voltage $V_{\rm C}$ vs. Peak Pulse Current $I_{\rm PP}$

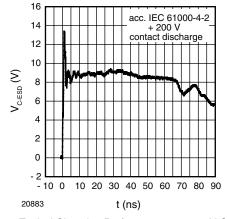


Figure 7. Typical Clamping Performance at + 200 V Contact Discharge (acc. IEC 61000-4-2)

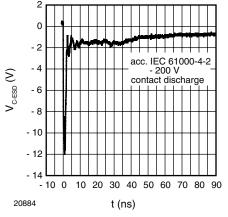


Figure 8. Typical Clamping Performance at - 200 V Contact Discharge (acc. IEC 61000-4-2)



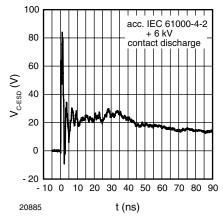


Figure 9. Typical Clamping Performance at + 6 kV Contact Discharge (acc. IEC 61000-4-2)

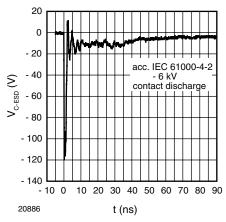
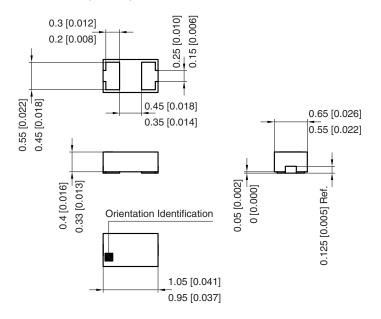
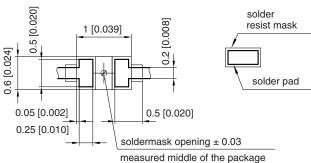


Figure 10. Typical Clamping Performance at - 6 kV Contact Discharge (acc. IEC 61000-4-2)

Package Dimensions in millimeters (inches): LLP1006-2L



foot print recommendation:



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VBUS051BD-HD1



Vishay Semiconductors

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

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